

## APPLICATION DATA SHEET

### Inventor Information

Inventor One Given Name::	Dae Sung
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Name Suffix::	
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State or Province::	Seoul
Country::	Korea
Postal or Zip Code	
Citizenship Country::	Korea

### Correspondence Information

Correspondence Customer Number::	6449
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### Application Information

Title Line One::	MICRO LEADFRAME PACKAGE HAVING OBLIQUE
Title Line One::	ETCHING
Total Drawing Sheets::	6
Formal Drawings?::	Yes
Application Type::	Utility Application
Docket Number::	1751-344
Secrecy Order in Parent Appl?::	No

### Representative Information

Representative Customer Number::	6449
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### Prior Foreign Applications

Foreign Application One::	2002-66122
Filing Date::	October 29, 2002
Country::	Korea
Priority Claimed::	Yes

### Assignment Information

Assignee name::	SIGNETICS KOREA CO., LTD.
Street of mailing address::	483 Beopheung-ri, Tanhyun-myun
City of mailing address::	Paju-city
State or Province of mailing address::	Kyungki-do
Country of mailing address::	Korea
Postal or Zip Code of mailing address::	